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- and -

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UNITED STATES BANKRUPTCY COURT SOUTHERN DISTRICT OF NEW YORK

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In re : Chapter 11

DELPHI CORPORATION, et al., : Case No. 05-44481 (RDD)

(Jointly Administered)

Debtors.

JULY 20, 2009 NOTICE OF FILING OF AMENDED PLAN EXHIBIT 8.1(a) WITH RESPECT TO FIRST AMENDED JOINT PLAN OF REORGANIZATION OF DELPHI CORPORATION AND CERTAIN AFFILIATES, DEBTORS AND DEBTORS-IN-POSSESSION (AS MODIFIED)

("JULY 20, 2009 NOTICE OF FILING AMENDED PLAN EXHIBIT 8.1(a)")

- 1. On June 16, 2009, Delphi Corporation ("Delphi") and certain of its subsidiaries and affiliates, debtors and debtors-in-possession in the above-captioned cases (the "Debtors"), filed the First Amended Plan Of Reorganization Of Delphi Corporation And Certain Affiliates, Debtors And Debtors-In-Possession (As Modified) (the "Modified Plan") (Docket No. 17030).
- 2. On the same date, the Debtors also filed the Supplement To First Amended Disclosure Statement With Respect To First Amended Joint Plan Of Reorganization Of Delphi Corporation And Certain Affiliates, Debtors And Debtors-In-Possession (As Modified) (Docket No. 17031).
- 3. Also on June 16, 2009, the Court entered the Order (A)(I) Approving Modifications To Debtors' First Amended Plan Of Reorganization (As Modified) And Related Disclosures And Voting Procedures And (II) Setting Final Hearing Date to Consider Modifications to Confirmed First Amended Plan Of Reorganization And (B) Setting Administrative Expense Claims Bar Date And Alternative Transaction Hearing Date (the "Modification Procedures Order") (Docket No. 17032).
- 4. Paragraph 4 of the Modification Procedures Order requires that the Debtors file all exhibits and schedules (including all amendments thereto, the "Plan Exhibits") to the Modified Plan with the Court on or before July 2, 2009. On July 2, 2009, in compliance with paragraph 4 of the Modification Procedures Order, the Debtors filed the following Plan Exhibits (Docket No. 17557):

PLAN EXHIBIT	DESCRIPTION
7.3	Restructuring Transactions Notice
7.4(a)	Certificate Of Incorporation For Reorganized DPH Holdings
7.4(b)	Bylaws Of Reorganized DPH Holdings
7.7	Certain Schedules and Exhibits to Master Disposition Agreement Filed June 16, 2009
7.9	Post-Confirmation Reorganized DPH Holdings Share Trust Agreement
7.11	Management Compensation Plan
7.17	Delphi-PBGC Settlement Agreement
7.19	Retained Causes Of Action
8.1(a)	Executory Contracts And Unexpired Leases To Be Rejected
10.5	Administrative Claim Request Form

- 5. All Plan Exhibits are subject to all of the provisions of the Modified Plan including, without limitation, Article 14.3, under which the Debtors have reserved the right to alter, amend, or modify the Modified Plan or any Exhibits thereto under section 1127(a) of the Bankruptcy Code at any time prior to the Final Modification Hearing.
- 6. In accordance with Article 14.3 of the Modified Plan, the Debtors have today filed amended Exhibit 8.1(a) (Executory Contracts And Unexpired Leases To Be Rejected).
- 7. Copies of the Plan Exhibits can be obtained at http://www.nysb.uscourts.gov or free of charge at http://www.delphidocket.com or, upon reasonable written request, from the Creditor Voting Agent, Kurtzman Carlson Consultants LLC, 2335 Alaska Avenue, El Segundo, California 90245, Att'n: Delphi Corporation, et al.

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Dated: New York, New York

July 20, 2009

SKADDEN, ARPS, SLATE, MEAGHER & FLOM LLP

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Attorneys for Delphi Corporation, <u>et al.</u>, Debtors and Debtors-in-Possession Amended Exhibit 8.1(a)

Executory Contracts And Unexpired Leases To Be Rejected

All Plan Exhibits are subject to all of the provisions of the First Amended Joint Plan Of Reorganization Of Delphi Corporation And Certain Affiliates, Debtors And Debtors-In-Possession (As Modified) (Docket No. 17030) (as subsequently modified or amended, the "Modified Plan"), including, without limitation, Article 14.3, under which the Debtors have reserved the right to alter, amend, or modify the Modified Plan or any Exhibits thereto.

Amended Exhibit 8.1(a)

Executory Contracts And Unexpired Leases To Be Rejected

- 1. Learjet Agreement with Bank of America N.A., dated March 30, 2001
- 2. Charter Agreement between Delphi Automotive Systems Human Resources, LLC and Automotive Air Charter, Inc., dated Nov. 26, 2001
- 3. Aircraft Management Agreement between Delphi Automotive Systems Human Resources, LLC and Pentastar Aviation, LLC, dated Nov. 26, 2001
- 4. Consent to Aircraft Management Agreement and Charter Agreement and Assignment, between Delphi Automotive Systems Human Resources, LLC, Bank of America N.A., Automotive Air Charter, Inc., and Pentastar Aviation, LLC, dated Nov. 27, 2001 and Dec. 16, 2003
- 5. Challenger Agreement with Bank of America N.A., dated March 30, 2001
- 6. Charter Agreement between Delphi Automotive Systems Human Resources, LLC and Automotive Air Charter, Inc., dated Nov. 26, 2001
- 7. Aircraft Management Agreement between Delphi Automotive Systems Human Resources, LLC and Pentastar Aviation, LLC, dated Nov. 26, 2001
- 8. Consent to Aircraft Management Agreement and Charter Agreement and Assignment, between Delphi Automotive Systems Human Resources, LLC, Bank of America N.A., Automotive Air Charter, Inc., and Pentastar Aviation, LLC, dated Nov. 27, 2001 and Dec. 16, 2003
- 9. Eagle Services Plan Agreement No. 0692-01 between Delphi Automotive Systems Human Resources LLC and Pratt & Whitney Canada Corp. dated January 31, 2002
- 10. Learjet Smart Parts Plus Agreement SP-60237-61 between Delphi Automotive Systems Human Resources LLC and Learjet Inc. dated February 11, 2002
- 11. Smart Parts Plus Agreement Contract #SP-5498-61 between Delphi Automotive Systems Human Resources LLC and Bombardier Inc.
- 12. CF34 Maintenance Cost Per Hour ("MCPH") Engine Service Agreement Reference Number ESI-01-0763C between Delphi Automotive Systems Human Resources LLC and GE Engine Services, Inc. dated February 21, 2002.
- 13. Warehouse Lease between Delphi Automotive Systems LLC and Donald R. and Sarah E. Sweeton, dated Dec. 22, 1999 and subsequently amended, with most recent amendment, the Fourth Amendment, dated Dec. 10, 2004

- 14. Master Goods Agreement between Delphi Corporation and Apple Computer Inc. dated May 1, 2004.
- 15. Lease Agreement (GM 91A-5) and Lease Supplements (GM 91A-5A and 91A-5C) between Delphi Automotive Systems LLC (as assignee of General Motors Corporation) and Comerica Bank (as Owner Participant) dated September 27, 1991.
- 16. All Change In Control Agreements between the Debtors and any person entered into prior to the Petition Date.
- 17. All Employment Agreements between the Debtors and any person entered into prior to the Petition Date.
- 18. Tacoma-Corolla Consulting and Technical Support Agreement between Delphi Automotive Systems LLC and The Furukawa Electric Co., Ltd. dated June 28, 2005.
- 19. Intellectual Property License, Restricted Use, and Technical Assistance Agreement among Delphi Technologies, Inc., Delphi Automotive Systems LLC and The Furukawa Electric Co. Ltd.
- 20. Contract No. 46288 with STANLEY ELECTRIC OF A. INC
- 21. Contract No. 46854 with STANLEY ELECTRIC OF A. INC
- 22. Contract No. 52593 with WORLD PRODUCTS INC
- 23. Contract No. 50252 with WORLD PRODUCTS INC
- 24. Contract No. 55561 with HAERTER STANZTECHNIK GMBH
- 25. Contract No. 53977 with OMRON DUALTEC AUTOMOTIVE ELEC
- 26. Contract No. 50063 with S T MICROELECTRONICS INC
- 27. Contract No. 46695 with PHILLIPS PLASTICS CORP
- 28. Contract No. 53074 with PARLEX CORPORATION
- 29. Contract No. 50579 with S T MICROELECTRONICS INC
- 30. Contract No. 54118 with STANLEY ELECTRIC OF A. INC
- 31. Contract No. 55779 with SUMCO INC
- 32. Contract No. 54106 with OSRAM
- 33. Contract No. 55403 with ON SEMICONDUCTOR LLC
- 34. Contract No. 54506 with CENTURY MOLD & TOOL CO INC

- 35. Contract No. 46247 with PHILLIPS PLASTICS CORP
- 36. Contract No. 54982 with J K L COMPONENTS
- 37. Contract No. 46246 with PHILLIPS PLASTICS CORP
- 38. Contract No. 54536 with CENTURY MOLD & TOOL CO INC
- 39. Contract No. 48417 with PHILLIPS PLASTICS CORP
- 40. Contract No. 50576 with S T MICROELECTRONICS INC
- 41. Contract No. 53073 with PARLEX CORPORATION
- 42. Contract No. 53285 with PHILLIPS PLASTICS CORP
- 43. Contract No. 48419 with PHILLIPS PLASTICS CORP
- 44. Contract No. 48415 with PHILLIPS PLASTICS CORP
- 45. Contract No. 52016 with ROWLEY SPRING CORP
- 46. Contract No. 49833 with ENGINEERED PLASTIC COMP
- 47. Contract No. 50322 with MURATA ELECTRONICS INC
- 48. Contract No. 53288 with PHILLIPS PLASTICS CORP
- 49. Contract No. 53168 with SYN TECH LTD
- 50. Contract No. 49609 with SYN TECH LTD
- 51. Contract No. 48418 with PHILLIPS PLASTICS CORP
- 52. Contract No. 48032 with STANLEY ELECTRIC OF A. INC
- 53. Contract No. 52594 with MURATA ELECTRONICS INC
- 54. Contract No. 49817 with MURATA ELECTRONICS INC
- 55. Contract No. 53112 with LITTELFUSE INC
- 56. Contract No. 50062 with S T MICROELECTRONICS INC
- 57. Contract No. 54925 with STANLEY ELECTRIC OF A. INC
- 58. Contract No. 52794 with LITTELFUSE INC
- 59. Contract No. 54009 with STANLEY ELECTRIC OF A. INC

- 60. Contract No. 54108 with OSRAM
- 61. Contract No. 52809 with PEC OF AMERICA
- 62. Contract No. 49822 with MURATA ELECTRONICS INC
- 63. Contract No. 46216 with ON SEMICONDUCTOR LLC
- 64. Contract No. 49682 with NICHICON CORP
- 65. Contract No. 55375 with NICHICON CORP
- 66. Contract No. 40804 with TELLA TOOL & MFG
- 67. Contract No. 53758 with PHILLIPS PLASTICS CORP
- 68. Contract No. 48414 with PHILLIPS PLASTICS CORP
- 69. Contract No. 50578 with S T MICROELECTRONICS INC
- 70. Contract No. 47208 with ARGENT AUTOMOTIVE SYSTEMS INC
- 71. Contract No. 50577 with S T MICROELECTRONICS INC
- 72. Contract No. 46221 with ON SEMICONDUCTOR LLC
- 73. Contract No. 53759 with PHILLIPS PLASTICS CORP
- 74. Contract No. 51963 with ROWLEY SPRING CORP
- 75. Contract No. 54856 with OMRON DUALTEC AUTOMOTIVE ELEC
- 76. Contract No. 52793 with LITTELFUSE INC
- 77. Contract No. 46223 with ON SEMICONDUCTOR LLC
- 78. Contract No. 53248 with ITT CANNON SWITCH PRODUCTS 2
- 79. Contract No. 47531 with NICHICON CORP
- 80. Contract No. 45005 with PHILLIPS PLASTICS CORP
- 81. Contract No. 52048 with ROWLEY SPRING CORP
- 82. Contract No. 53555 with NICHICON CORP
- 83. Contract No. 55651 with ON SEMICONDUCTOR LLC
- 84. Contract No. 41267 with GRAND TRAVERSE STAMPING

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- 85. Contract No. 48856 with COMUS INTERNATIONAL INC.
- 86. Contract No. 46418 with PHILLIPS PLASTICS CORP
- 87. Contract No. 56191 with VISHAY AMERICAS INC
- 88. Contract No. 52032 with ROWLEY SPRING CORP
- 89. Contract No. 47079 with WAMCO INC
- 90. Contract No. 54061 with S T MICROELECTRONICS INC
- 91. Contract No. 54875 with MURATA ELECTRONICS INC
- 92. Contract No. 54017 with PLASTIC COMPONENTS INC
- 93. Contract No. 53469 with ON SEMICONDUCTOR LLC
- 94. Contract No. 52792 with LITTELFUSE INC
- 95. Contract No. 55391 with ST CLAIR PLASTICS
- 96. Contract No. 55714 with INFINEON TECHNOLOGIES CORP
- 97. Contract No. 52059 with ROWLEY SPRING CORP
- 98. Contract No. 52791 with LITTELFUSE INC
- 99. Contract No. 53008 with LITTELFUSE INC
- 100. Contract No. 55784 with SUMCO INC
- 101. Contract No. 54150 with LITTELFUSE INC
- 102. Contract No. 48416 with PHILLIPS PLASTICS CORP
- 103. Contract No. 41219 with SYN TECH LTD
- 104. Contract No. 54481 with MURATA ELECTRONICS INC
- 105. Contract No. 54487 with SYN TECH LTD
- 106. Contract No. 40643 with SOFANOU INC
- 107. Contract No. 54089 with MURATA ELECTRONICS INC
- 108. Contract No. 49832 with ENGINEERED PLASTIC COMP
- 109. Contract No. 55794 with STANLEY ELECTRIC OF A. INC

- 110. Contract No. 53427 with ON SEMICONDUCTOR LLC
- 111. Contract No. 52057 with ROWLEY SPRING CORP
- 112. Contract No. 46222 with ON SEMICONDUCTOR LLC
- 113. Contract No. 53411 with LITTELFUSE INC
- 114. Contract No. 53823 with ON SEMICONDUCTOR LLC
- 115. Contract No. 54454 with MURATA ELECTRONICS INC
- 116. Contract No. 52393 with SYN TECH LTD
- 117. Contract No. 52353 with ON SEMICONDUCTOR LLC
- 118. Contract No. 50858 with KEMET ELECTRONICS CORP
- 119. Contract No. 52051 with ROWLEY SPRING CORP
- 120. Contract No. 54682 with PHILLIPS PLASTICS CORP
- 121. Contract No. 54062 with ON SEMICONDUCTOR LLC
- 122. Contract No. 52053 with ROWLEY SPRING CORP
- 123. Contract No. 54455 with MURATA ELECTRONICS INC
- 124. Contract No. 50647 with NICHICON CORP
- 125. Contract No. 52049 with ROWLEY SPRING CORP
- 126. Contract No. 47130 with SYN TECH LTD
- 127. Contract No. 52030 with ROWLEY SPRING CORP
- 128. Contract No. 50699 with PLASTIC COMPONENTS INC
- 129. Contract No. 47272 with PHILLIPS PLASTICS CORP
- 130. Contract No. 47075 with NICHICON CORP
- 131. Contract No. 46210 with ON SEMICONDUCTOR LLC
- 132. Contract No. 53708 with SOFANOU INC
- 133. Contract No. 49038 with SYN TECH LTD
- 134. Contract No. 54855 with ENGINEERED PLASTICS COMPONENTS

- 135. Contract No. 52055 with ROWLEY SPRING CORP
- 136. Contract No. 48843 with STANLEY ELECTRIC OF A. INC
- 137. Contract No. 55168 with ON SEMICONDUCTOR LLC
- 138. Contract No. 50582 with ON SEMICONDUCTOR LLC
- 139. Contract No. 52050 with ROWLEY SPRING CORP
- 140. Contract No. 50333 with MURATA ELECTRONICS INC
- 141. Contract No. 52423 with JACKSON SPRING & MFG. CO. INC
- 142. Contract No. 54479 with MURATA ELECTRONICS INC
- 143. Contract No. 55544 with ON SEMICONDUCTOR LLC
- 144. Contract No. 54444 with NICHICON CORP
- 145. Contract No. 50325 with MURATA ELECTRONICS INC
- 146. Contract No. 55456 with ON SEMICONDUCTOR LLC
- 147. Contract No. 52043 with ROWLEY SPRING CORP
- 148. Contract No. 50857 with KEMET ELECTRONICS CORP
- 149. Contract No. 54459 with MURATA ELECTRONICS INC
- 150. Contract No. 46214 with ON SEMICONDUCTOR LLC
- 151. Contract No. 55402 with ON SEMICONDUCTOR LLC
- 152. Contract No. 52052 with ROWLEY SPRING CORP
- 153. Contract No. 55172 with ON SEMICONDUCTOR LLC
- 154. Contract No. 49820 with MURATA ELECTRONICS INC
- 155. Contract No. 55003 with MURATA ELECTRONICS INC
- 156. Contract No. 54983 with NICHICON CORP
- 157. Contract No. 47206 with ON SEMICONDUCTOR LLC
- 158. Contract No. 50584 with ON SEMICONDUCTOR LLC
- 159. Contract No. 45226 with ROHM ELECTRONICS USA, LLC

- 160. Contract No. 53289 with PHILLIPS PLASTICS CORP
- 161. Contract No. 53822 with ON SEMICONDUCTOR LLC
- 162. Contract No. 50334 with MURATA ELECTRONICS INC
- 163. Contract No. 54053 with ON SEMICONDUCTOR LLC
- 164. Contract No. 55579 with MURATA ELECTRONICS INC
- 165. Contract No. 46215 with ON SEMICONDUCTOR LLC
- 166. Contract No. 48956 with ON SEMICONDUCTOR LLC
- 167. Contract No. 54154 with MURATA ELECTRONICS INC
- 168. Contract No. 54090 with MURATA ELECTRONICS INC
- 169. Contract No. 47204 with ON SEMICONDUCTOR LLC
- 170. Contract No. 50828 with KEMET ELECTRONICS CORP
- 171. Contract No. 55178 with ON SEMICONDUCTOR LLC
- 172. Contract No. 50331 with MURATA ELECTRONICS INC
- 173. Contract No. 55711 with MURATA ELECTRONICS INC
- 174. Contract No. 550045174 with CINCH CONNECTORS INC
- 175. Contract No. 550044800 with CINCH CONNECTORS INC
- 176. Contract No. 550042117 with CINCH CONNECTORS INC
- 177. Contract No. P5420075 with HONEYWELL SENSING & EFT CONTROL
- 178. Contract No. P4120093 with COMMERCIAL SPRING & TOOL EFT COMPANY LIMITED
- 179. Contract No. P4120078 with SMALL PARTS INC EFT
- 180. Contract No. 550069607 with Fujitsu Ten

This amended Exhibit 8.1(a) amends the version filed on July 2, 2009. Subject to the Master Disposition Agreement, the Debtors reserve the right to file a motion on or before the Modification Approval Date to reject any executory contract or unexpired lease. In addition, the Debtors reserve the right to further amend, modify, supplement, or otherwise change Exhibit 8.1(a) on or before the Modification Approval Date. It is the Debtors' position that the executory contracts and unexpired leases on this amended Exhibit 8.1(a) have expired

or terminated (and not otherwise extended), but out of an abundance of caution the Debtors are including these executory contracts and unexpired leases on this amended Exhibit 8.1(a). Furthermore, the Debtors may be a party to one or more post-petition contracts that utilize the same contract number as a contract set forth in this amended Exhibit 8.1(a). Such contract numbers are being utilized by the Debtors for administrative convenience only and the inclusion of a pre-petition executory contract on this amended Exhibit 8.1(a) does not impact the validity or enforceability of any post-petition contract utilizing the same contract number.